

General Description:

The LWT1H6AM uses SGT technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. The package form is SOT23, which accords with the ROHS standard and Halogen Free standard.

Features:

- Fast Switching
- Low Gate Charge and $R_{DS(ON)}$
- Low Reverse transfer capacitances

Applications:

- DC-DC Converter
- Portable Equipment
- Power Management

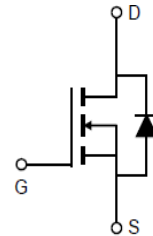


V_{DSS}	100	V
I_D	4.0	A
P_D	1.5	W
$R_{DS(ON)}$ TYPE	100	mΩ

Marking and Pin Assignment



Inner Equivalent Principium Chart



Package Marking and Ordering Information:

Marking	Part Number	Package	Packing	Qty.
T1H6A	LWT1H6AM	SOT23	Reel	3000 Pcs

Absolute Maximum Ratings:

Symbol	Parameter		Value	Units
V_{DSS}	Drain-to-Source Voltage		100	V
I_D	Continuous Drain Current	$T_A=25^{\circ}\text{C}$	4.0	A
	Continuous Drain Current	$T_A=100^{\circ}\text{C}$	2.5	A
I_{DM}^{a1}	Pulsed Drain Current		12	A
V_{GS}	Gate-to-Source Voltage		± 20	V
P_D	Power Dissipation		1.5	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range		150, -55 to 150	$^{\circ}\text{C}$
T_L	Maximum Temperature for Soldering		260	$^{\circ}\text{C}$

Thermal Characteristics:

Symbol	Parameter	Value	Units
$R_{\theta JA}^{a2}$	Thermal Resistance, Junction-to-Ambient	83	$^{\circ}\text{C/W}$

Electrical Characteristic ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise specified):

Static Characteristics						
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
V_{DSS}	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	100	--	--	V
I_{DSS}	Drain to Source Leakage Current	$V_{DS}=100V, V_{GS}=0V$	--	--	1.0	μA
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS}=+20V, V_{DS}=0V$	--	--	100	nA
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS}=-20V, V_{DS}=0V$	--	--	-100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1.3	1.8	2.4	V
$R_{DS(ON)1}$	Drain-to-Source On-Resistance	$V_{GS}=10V, I_D=4.0A$	--	100	120	$m\Omega$
$R_{DS(ON)2}$	Drain-to-Source On-Resistance	$V_{GS}=4.5V, I_D=3.0A$	--	120	145	$m\Omega$

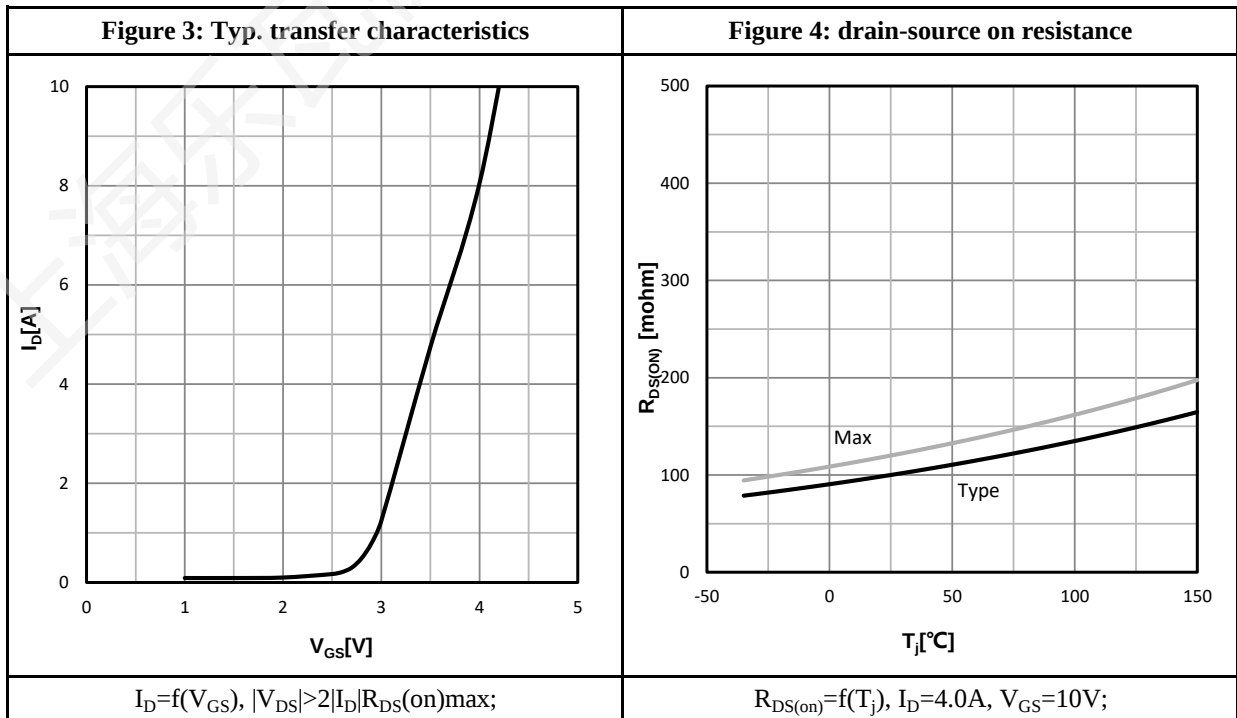
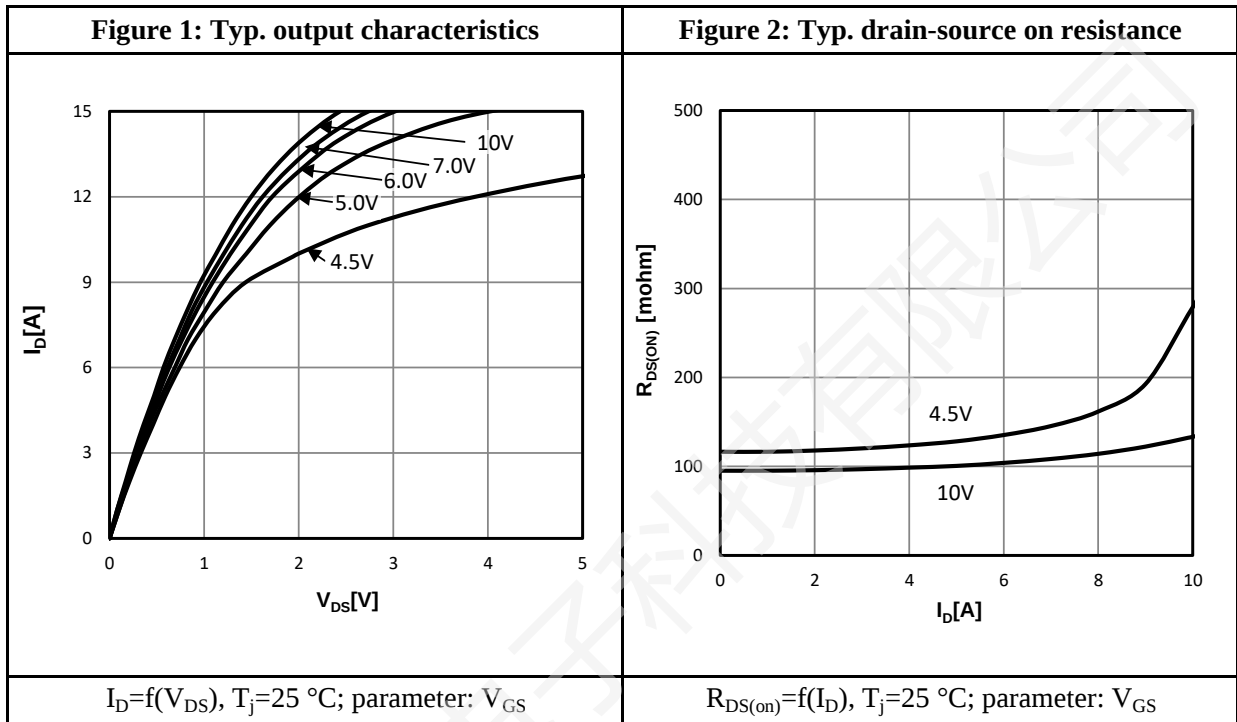
Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
C_{iss}	Input Capacitance	$V_{GS} = 0V$	--	126	--	pF
C_{oss}	Output Capacitance	$V_{DS} = 50V$	--	41	--	
C_{rss}	Reverse Transfer Capacitance	$f = 1.0MHz$	--	2.0	--	
R_G	Gate resistance	$V_{GS}=0V, V_{DS}=0V, f=1MHz$	--	5.8	--	Ω

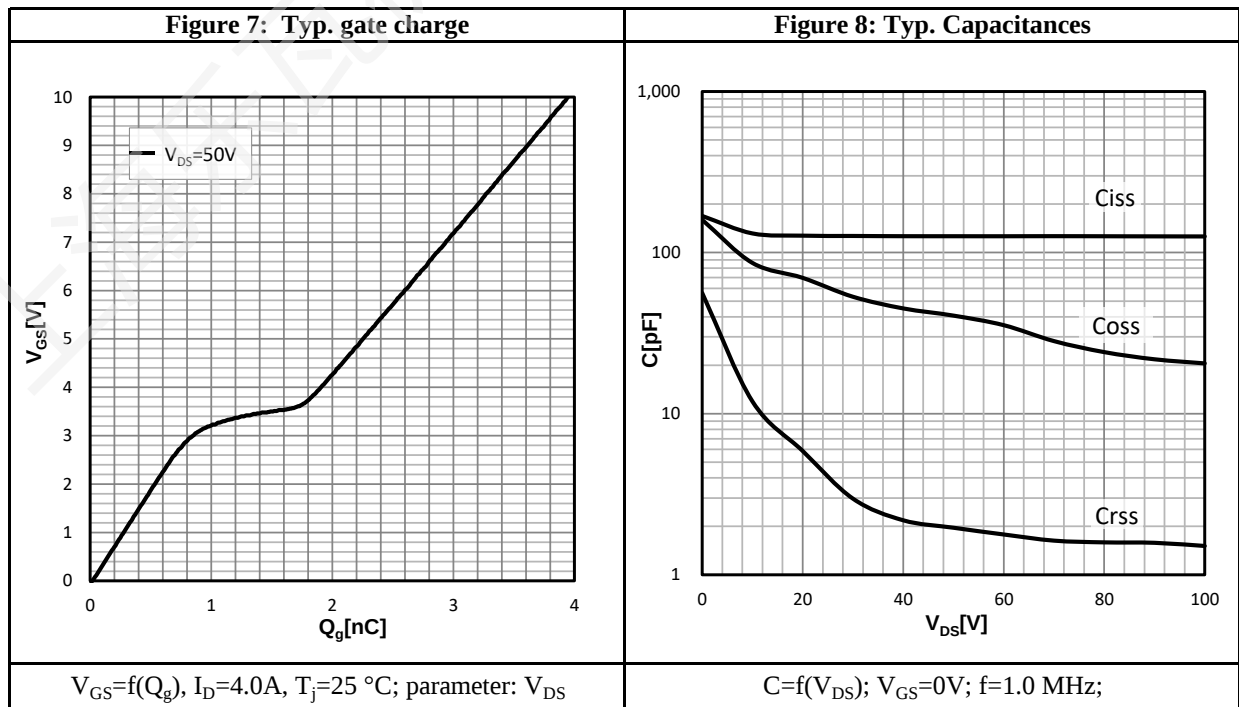
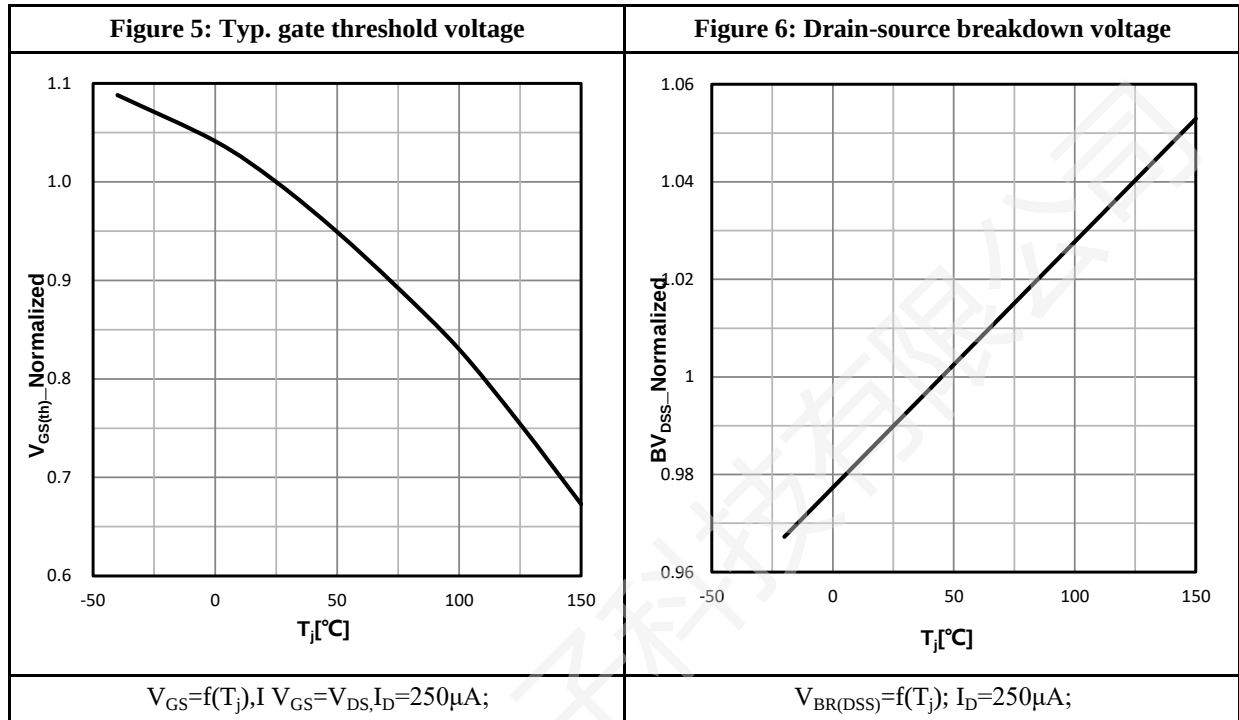
Resistive Switching Characteristics						
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
$t_{d(ON)}$	Turn-on Delay Time	$I_D = 4.0A$	--	4.5	--	ns
t_r	Rise Time	$V_{DS} = 50V$	--	1.5	--	
$t_{d(OFF)}$	Turn-Off Delay Time	$V_{GS} = 10V$	--	8.0	--	
t_f	Fall Time	$R_G = 5.0\Omega$	--	3.4	--	
Q_g	Total Gate Charge	$V_{GS} = 10V$	--	4.0	--	nC
Q_{gs}	Gate Source Charge	$V_{DS} = 50V$	--	1.1	--	
Q_{gd}	Gate Drain Charge	$I_D = 4.0A$	--	0.8	--	

Source-Drain Diode Characteristics						
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
I_S	Diode Forward Current	$T_A = 25\text{ }^{\circ}\text{C}$	--	--	4.0	A
V_{SD}	Diode Forward Voltage	$I_S=4.0A, V_{GS}=0V$	--	--	1.2	V
t_{rr}	Reverse Recovery Time	$I_S=4.0A, V_{DD}=50V$	--	26	--	ns
Q_{rr}	Reverse Recovery Charge	$dI/dt=100A/\mu s$	--	20	--	nC

a1: Repetitive rating; pulse width limited by maximum junction temperature

a2: Surface Mounted on FR4 Board, $t \leq 10\text{ sec.}$

Characteristics Curve:




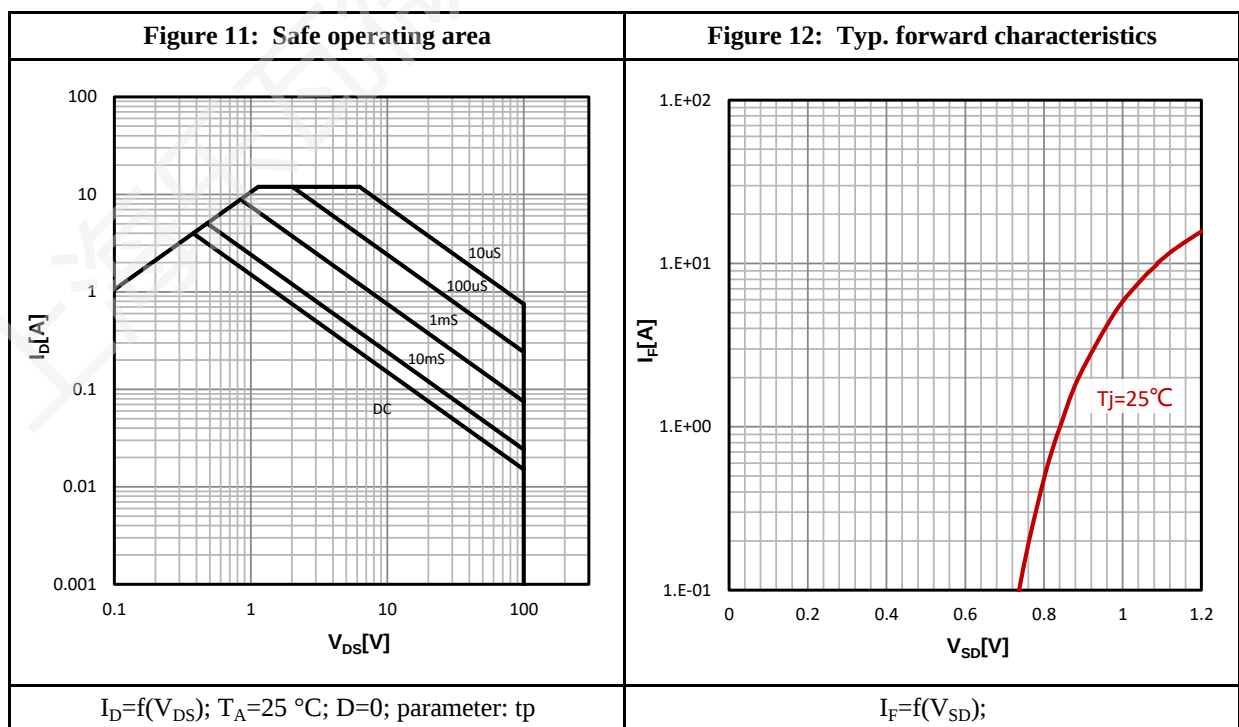
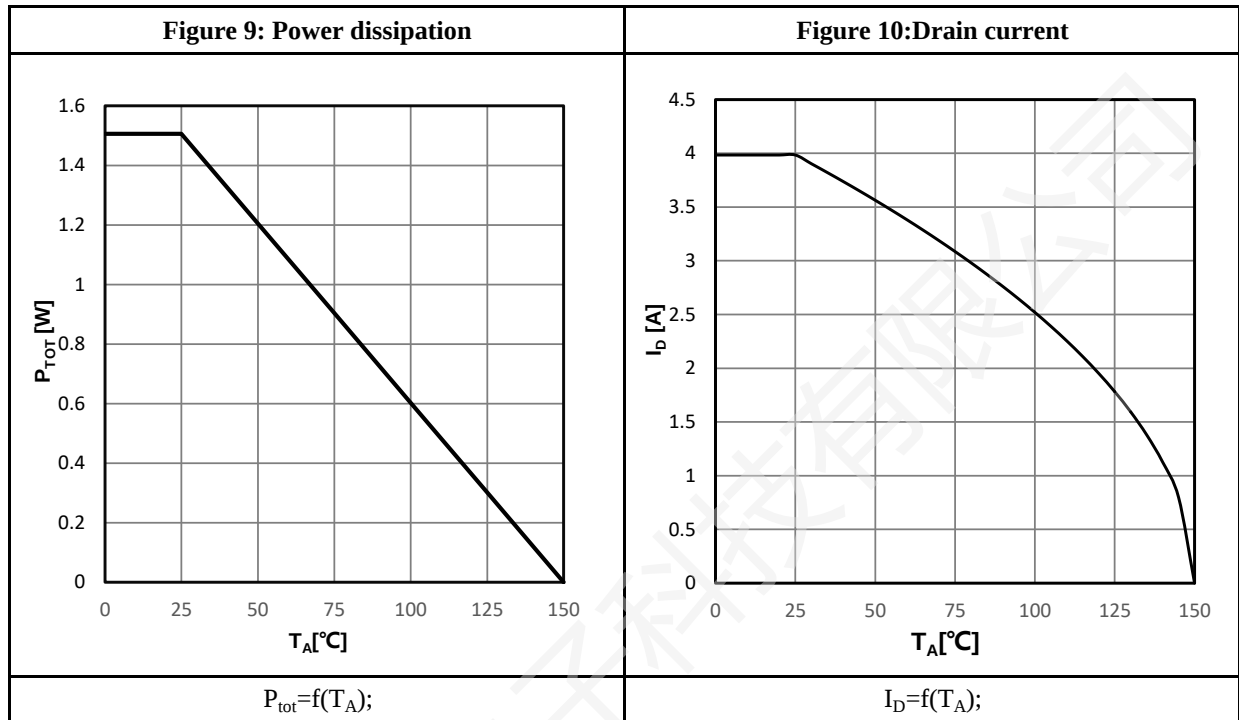
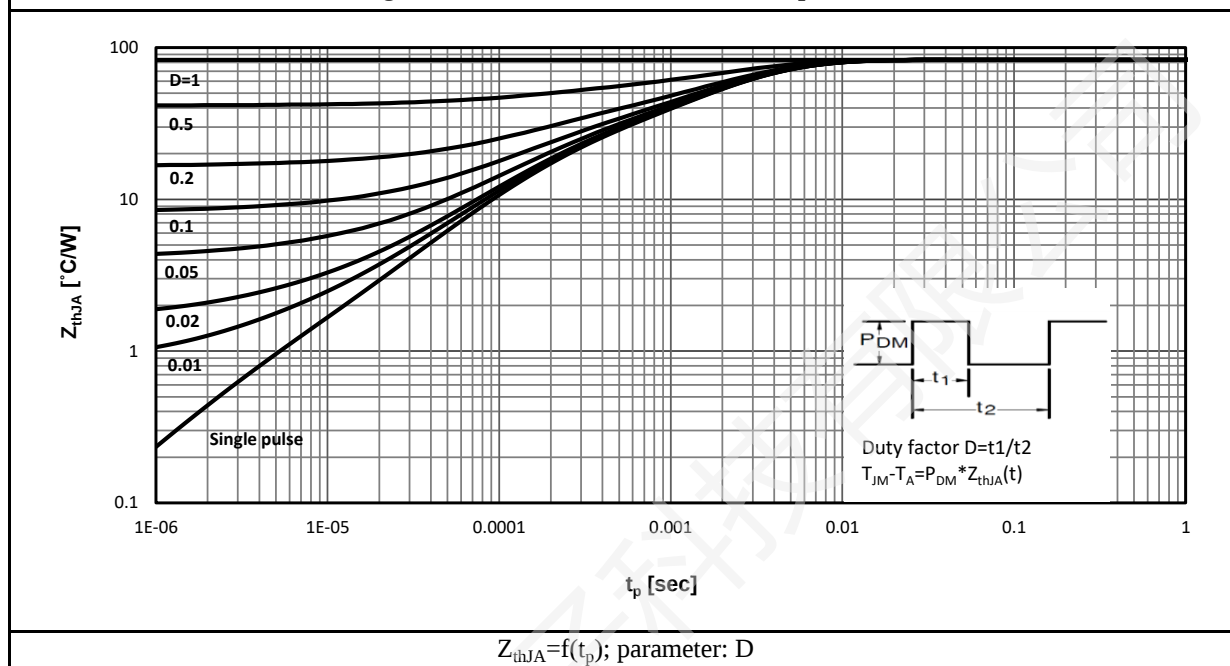
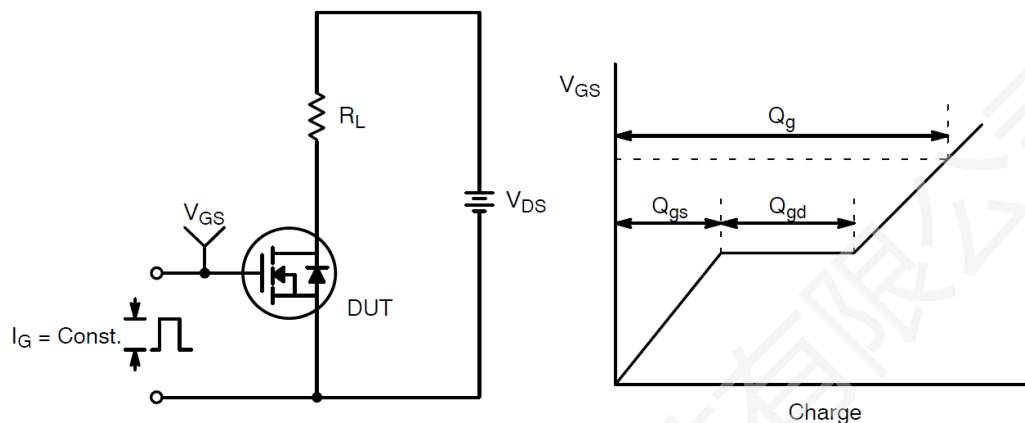
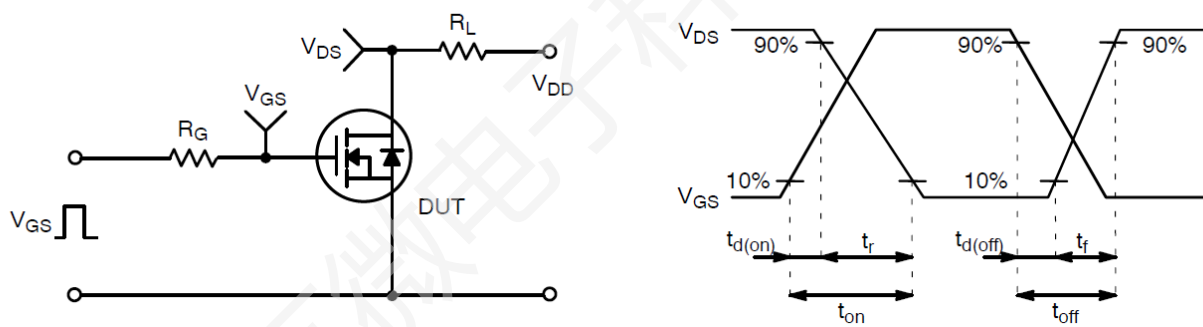
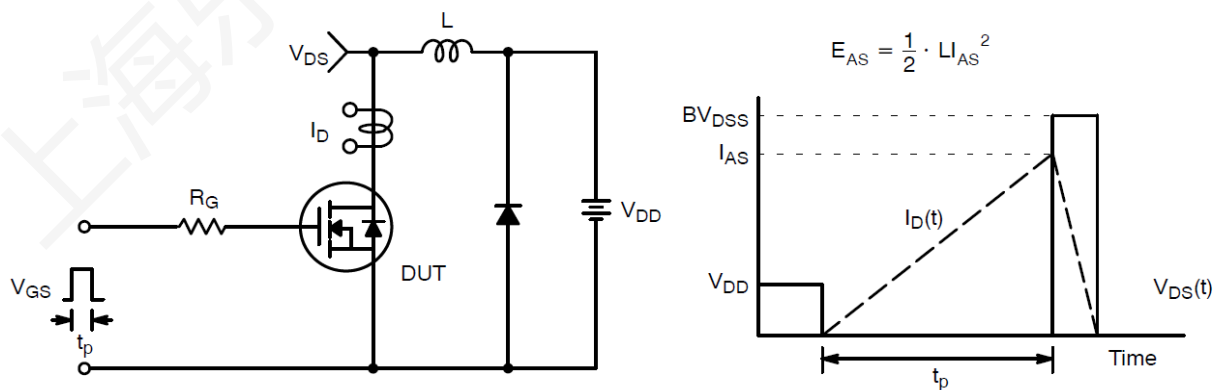
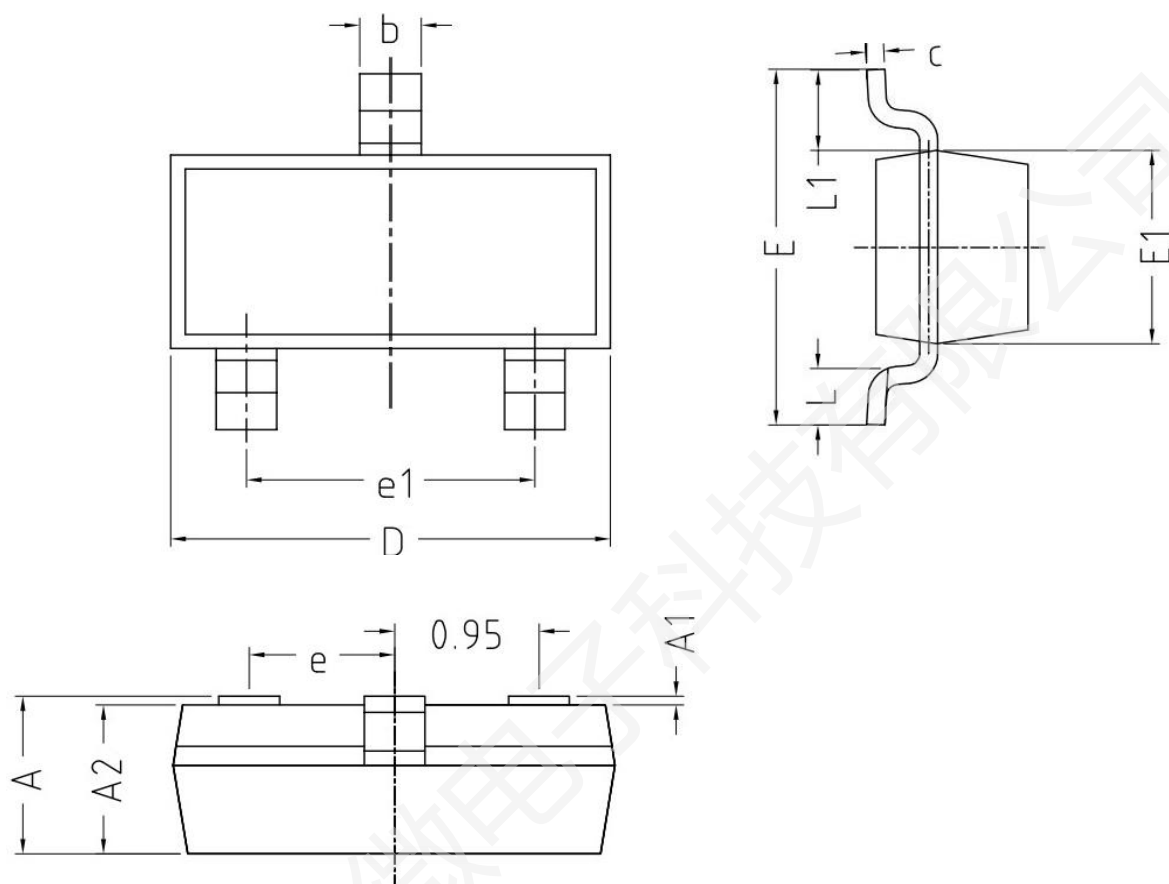


Figure 13: Max. Transient Thermal Impedance


Test Circuit & Waveform:

Figure 14: Gate Charge Test Circuit & Waveform

Figure 15: Resistive Switching Test Circuit & Waveforms

Figure 16: Unclamped Inductive Switching Test Circuit & Waveforms

Package Outline:

COMMON IN DIMENSION (MM)

Symbol	Min.	Nom.	Max.
A	0.900	1.050	1.150
A1	0.000	0.050	0.100
A2	0.900	1.000	1.050
b	0.300	0.400	0.500
C	0.100	0.175	0.250
D	2.800	2.900	3.000
E	2.250	2.400	2.550
E1	1.200	1.300	1.400
e	0.950 TYP		
e1	1.800	1.900	2.000
L	0.290	0.395	0.500
L1	0.550REF		

Revision History:

Revison	Date	Descriptions
Rev 1.1	Apr.2025	“Electrical Characteristics” Update
Rev 1.0	Feb.2024	Initial Version

Disclaimer:

The information in this document is believed to be accurate and reliable. However, no responsibility is assumed by LW-Micro for its use. All operating parameters must be designed, validated and tested to ensure they meet the requirements of your application. LW-Micro reserves the right to make any specification and/or circuitry changes without prior notification. Before starting a brand-new project, please contact LW-Micro Sales to get the most recent relevant information.

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